



VGA OLED-XL™ Microdisplays

VGA OLED-XL MICRODISPLAY CAPABILITIES

Designed specifically for near-to-eye applications demanding high image quality, compact size, and very low power, the VGA OLED-XL active matrix microdisplay delivers crisp, high-contrast imagery via eMagin's True Black™ pixel technology. The voltage drive design provides dramatic improvement in pixel uniformity (in a 0.50 inch diagonal active area) requiring less than 60mW under typical monochrome operation (<150mW full color).

The VGA microdisplay provides versatility and flexibility for OEM developers through an FPGA driver design available on a separate, lower power driver board, or as source code for integration into end product electronics for maximum power efficiency. Additional enhancements include, digital interface, wider color gamut, on-chip temperature sensor and automatic compensation for luminance and gamma correction for consistent color and brightness over a wide range of operating temperatures.

The total pixel array of 680 x 520 can be used for electronic alignment of a 640 x 480 (VGA) window with the ability to move the image up to 20 pixels horizontally and/or vertically, or the entire array can be addressed pixel by pixel. Display feature and timing options are selected by means of registers that are programmed through the serial port or controlled through the FPGA.

Proven in military, commercial, and consumer systems, eMagin's portfolio of OLED microdisplays deliver high-resolution, flicker-free virtual images, even in extreme temperatures and high-vibration conditions that challenge legacy technologies.



VGA OLED-XL MICRODISPLAY ADVANTAGES

- Compact, lightweight, emissive display system
- High-contrast with very low power requirement
- Versatile driver FPGA
- Improved pixel uniformity
- Instant on at low temperatures; no heaters required
- Integrated temperature sensor
- High commercial/military ruggedness

APPLICATIONS

- Thermal sights
- Personal display systems
- Night vision/thermal imaging
- Command and control
- Field maintenance and repair
- Instrumentation and test equipment
- Mobile computing systems
- Augmented reality



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GENERAL OPERATING CHARACTERISTIC

FORMAT

- 640 (x 3) x 480
- Total pixel array 680 (x3) x 520

PIXEL ASPECT RATIO & PITCH

- 15 μ m square

COLOR PIXEL ARRANGEMENT

- R,G,B vertical stripe

VIEWING AREA

- 10.02 X 7.80 mm (0.50 inch diagonal)
- Electronic image centering (1 to 20 pixels H and V)

DISPLAY ASPECT RATIO

- 4:3

MECHANICAL ENVELOPE

- 16.5 x 18 x 5.01 mm (w/Hirose 50- pin DF 12 connector)

COLOR GAMUT

- >75% of NTSC gamut
- Up to 256 gray levels

UNIFORMITY

- >90% End to end
- >95% Pixel to pixel uniformity

CONTRAST RATIO

- >10,000:1
- Dimming ratio (combinable multiplier)
Analog mode >500:1

LUMINANCE MAXIMUM

- Color 400 cd/m²
- Monochrome White 1,800 cd/m²
- Monochrome Green 3,000 cd/m²

TEMPERATURE

- Operating: -46°C to >+70°C
- Storage: -55°C to +90°C

HUMIDITY

- 85% RH non-condensing

VIDEO INPUTS

R, G, B INPUTS

- RGB 30-bit digital

VIDEO FORMATS

- VGA
- Frame or Field sequential stereovision

VIDEO SIGNAL BANDWIDTH

- 50 MHz maximum

CONTROL & SERIAL INTERFACE

- I²C Serial Interface

FRAME RATE

- up to 120 Hz

POWER INTERFACE

POWER SUPPLY (V_{DD})

- 2.5 Vdc (logic), 5Vdc analog/display

TOTAL POWER DISSIPATION

- <150 mW typical (full color display)
- <60 mW typical (monochrome display)

* Data represent performance at 20°C for standard commercial and industrial pricing. Characteristics will vary with temperature requirements. Low-cost commercial or consumer operating specifications may vary.

ASSEMBLY DIAGRAM

